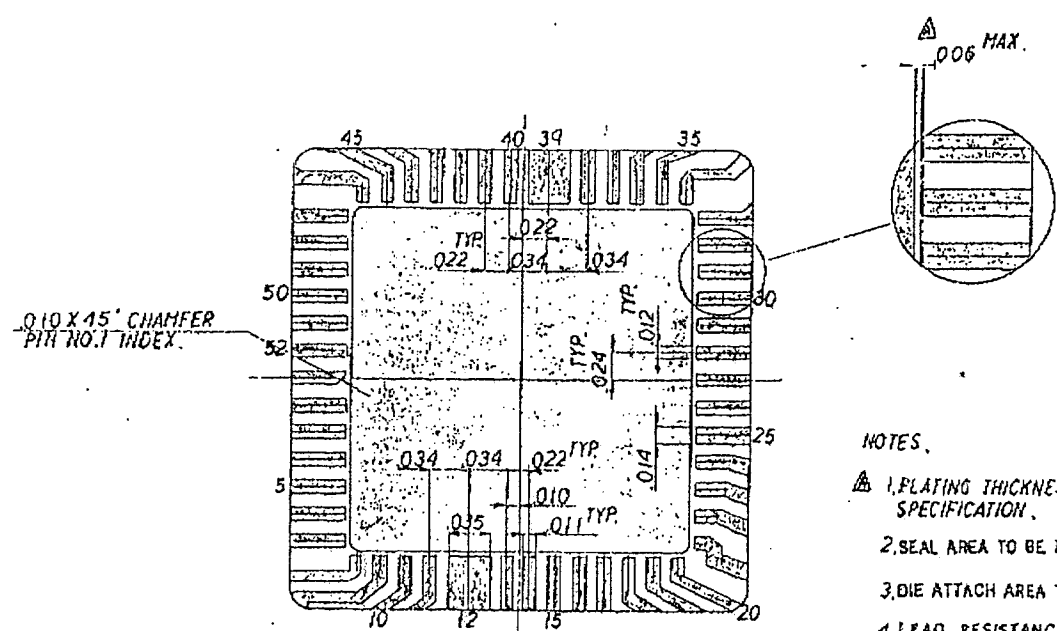


REVISIONS	NAME 52 LEAD FLAT PACKAGE				TOLERANCES UNLESS OTHERWISE SPECIFIED		S=0 NCRL-52TH D=0	
	SCALE 5:1		MATERIAL AS INDICATED		±1.0% NLT. ±.005		DRAWN K. Honda	
	DATE				APPROVED		DATE JUL 27 97	
	CHANGE				KYOTO CERAMIC CO., LTD.		KYOTO JAPAN	

DWG NO. KD-82524-A

JUN-24-98 MED 02:57 PM KYOCERA SAN JOSE FAX NO. 4084379533 JUL 13 1998 P. 02/02



NOTES.

1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE METALLIZED
3. DIE ATTACH AREA TO BE METALLIZED
4. LEAD RESISTANCE: 0.04 Ω MAX. AT PIN NO. 12, 39.
0.23 Ω MAX. AT PIN NO. 25, 52.
OTHER LESS THAN 1.0 Ω MAX.
5. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.

NOTES					NAME 52 LEAD FLAT PACKAGE		TOLERANCES UNLESS OTHERWISE SPECIFIED		DRG. W/	CHECKED
					SCALE	MATERIAL			A. J. J. J.	P. J. J. J.
Δ ADDED: 0.06 MAX. CHANGED: NOTE 1 CHANGE				DATE	BY	CHECKED	APPROVED	APPROVED	DATE	
				APR. 7. 83	A. J. J. J.	P. J. J. J.			JUL. 27. 82	
KYOTO CERAMIC CO., LTD.							KYOTO JAPAN	DWG. NO.	KD-82524-A 2/2	